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# PXIe-7820 Specifications

2022-09-29

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NI PXIe-7820R Specifications
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# NI PXIe-7820R Specifications

This document contains the specifications for the NI PXIe-7820R. Specifications are typical at 25 °C unless otherwise noted.

**Caution** Using the NI PXIe-7820R in a manner not described in this document may impair the protection the NI PXIe-7820R provides.

#### Digital I/O

Number of connectors			4		
Number of channels per connector			32		
Maximum frequency			80 MHz		
Compatibility			LVTTL, LVCMOS		
Logic family			Software-selectable		
Default software setting		3.3 V			
Logic Family	Input Low Voltage (V <sub>IL</sub> ) Inp		nput High Voltage (V <sub>IH</sub> )		
	Minimum	Maximum	М	inimum	Maximum
1.2 V	-0.3 V	0.40 V	0.	84 V	1.5 V
1.5 V	-0.3 V	0.50 V	1.	05 V	1.8 V
1.8 V	-0.3 V	0.60 V	1.	25 V	2.1 V
2.5 V	-0.3 V	0.70 V	1.	70 V	2.8 V
3.3 V	-0.3 V	0.80 V	2.	00 V	3.6 V

Table 1. Digital Input Logic Levels

Input leakage current	±15 μA maximum
Input impedance	50 kΩ typical, pull-down

Logic Family	Current	Output Low Voltage (V <sub>OL</sub> ) Maximum	Output High Voltage (V <sub>OH</sub> ) Minimum
1.2 V	100 µA	0.20 V	1.00 V
1.5 V	100 µA	0.20 V	1.25 V
1.8 V	100 µA	0.20 V	1.54 V
2.5 V	100 µA	0.20 V	2.22 V
3.3 V	100 µA	0.20 V	3.00 V
	4 mA	0.40 V	2.40 V

Table 2. Digital Output Logic Levels

Maximum DC output current per char	nnel
Source	4.0 mA
Sink	4.0 mA
Output impedance	50 Ω
Power-on state <sup>[1]</sup>	Programmable, by line
Protection <sup>[2]</sup>	±20 V, single line
Digital I/O voltage selection	Programmable, per connector, and defined at compilation (not run-time configurable)
Direction control of digital I/O channels	Per channel
Minimum I/O pulse width	6.25 ns

Minimum sampling period	5 ns

## External Clock

Direction	Input into device
Maximum input leakage	±15 μA
Characteristic impedance	50 Ω
Power-on state	Tristated
Minimum input	-0.3 V
Maximum input	3.6 V
Logic level	Inherited from programmed digital voltage selection per connector
Maximum input frequency	80 MHz

## Reconfigurable FPGA

FPGA type	Kintex-7 160T
Number of flip-flops	202,800
Number of LUTs	101,400
Embedded Block RAM	11,700 kbits
Number of DSP48 slices	600

Timebase	10, 40, 80, 100, 120, 160, or 200 MHz
Default timebase	40 MHz
Timebase reference source	PXI Express 100 MHz (PXIe_CLK100)
Timebase accuracy	±100 ppm, 250 ps peak-to-peak jitter
Data transfers	DMA, interrupts, programmed I/O

## Synchronization Resources

Input/output source	PXI_Trig<07>
Input source	PXI_Star, PXIe_DStarA, PXIe_DStarB, PXI_Clk10, PXIe_Clk100, External Clock <b>x</b>
Output source	PXIe_DStarC

#### **Bus Interface**

Form factor	x4 PXI Express, specification v1.0 compliant
Slot compatibility	x4, x8, and x16 PXI Express or PXI Express hybrid slots
Data transfers	DMA, interrupts, programmed I/O
Number of DMA channels	16

#### **Maximum Power Requirements**

Power requirements are dependent on the digital output loads and configuration of the LabVIEW FPGA VI used in your application.

+3.3 VDC (±5%)	3 A
+12 V	2 A

#### Physical Characteristics

**Note** If you need to clean the device, wipe it with a dry, clean towel.

Dimensions	16 cm by 10 cm (6.3 in. by 3.9 in.)		
Weight	183 g (0.403 lb)		
I/O connectors	x4 68-pin female high-density VHDCI type		

#### Environmental

Ambient Operating temperature (IEC 60068-2-1, IEC 60068-2-2)	0 °C to 55 °C
Ambient Storage temperature (IEC 60068-2-1, IEC 60068-2-2)	-40 °C to 71 °C
Operating humidity (IEC 60068-2-56)	10% RH to 90% RH, noncondensing
Storage humidity (IEC 60068-2-56)	5% RH to 95% RH, noncondensing

Pollution Degree	2
Maximum altitude	2,000 m at 25 °C

Indoor use only.

#### Shock and Vibration

Operational shock	30 g peak, half-sine, 11 ms pulse (Tested in accordance with IEC 60068-2-27. Meets MIL-PRF-28800F Class 2 limits.)			
Random vibration				
Operating 5 H	Iz to 500 Hz, 0.3 g <sub>rms</sub>			
Non-operating .5 Hz to 500 Hz, 2.4 g <sub>rms</sub> (Tested in accordance with IEC 60068-2-64. Meets MIL-PRF-28800F Class 3.)				

#### Safety Standards

This product meets the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1
- EN 60079-0:2012, EN 60079-15:2010
- IEC 60079-0: Ed 6, IEC 60079-15: Ed 4
- UL 60079-0: Ed 5, UL 60079-15: Ed 3
- CSA 60079-0: 2011, CSA 60079-15: 2012

**Note** For UL and other safety certifications, refer to the product label or the <u>Online Product Certification</u> section.

#### Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class B emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class B emissions
- EN 55022 (CISPR 22): Class B emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class B emissions
- AS/NZS CISPR 22: Class B emissions
- FCC 47 CFR Part 15B: Class B emissions
- ICES-001: Class B emissions

**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.

**Note** For EMC declarations and certifications, and additional information, refer to the **Online Product Certification** section.

# CE Compliance $C \in$

This product meets the essential requirements of applicable European Directives, as amended for CE marking, as follows:

- 2006/95/EC; Low-Voltage Directive (safety)
- 2004/108/EC; Electromagnetic Compatibility Directive (EMC)

#### **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI

products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

#### **Environmental Management**

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### EU and UK Customers

• At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit <u>ni.com/environment/weee</u>.

## 电子信息产品污染控制管理办法(中国 RoHS)

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Visit <u>ni.com/register</u> to register your NI product. Product registration facilitates technical support and ensures that you receive important information updates from NI.

NI corporate headquarters is located at 11500 N Mopac Expwy, Austin, TX, 78759-3504, USA.

#### NI PXIe-7820R Pinout

(	$\frown$		CONNECTOR (RDIO) CONNECTOR (RDIO)
GND	68 34	GND	NA NA
External Clock x*	67 33	GND	8 8
GND	66 32	GND	$\bigcirc$
DIO0	65 31	DIO1	A A A A A A A A A A A A A A A A A A A
GND	64 30	GND	TERMINAL 68 - Frailing TERMINAL 35
DIO2	63 29	DIO3	TERMINAL 34
GND	62 28	GND	
DIO4	61 27	DIO5	
GND	60 26	GND	
DIO6	59 25	DIO7	
GND	58 24	GND	
DIO8	57 23	DIO9	
GND	56 22	GND	TERMINAL 1
DIO10	55 21	DIO11	
GND	54 20	GND	TERMINAL 35
DIO12	53 19	DIO13	
GND	52 18	GND	
DIO14	51 17	DIO15	
GND	50 16	GND	
DIO16	49 15	DIO17	(C)(C)
GND	48 14	GND	
DIO18	47 13	DIO19	TERMINAL 68
GND	46 12	GND	TERMINAL 34 TERMINAL 1
DIO20	45 11	DIO21	
GND	44 10	GND	
DIO22	43 9	DIO23	
GND	42 8	GND	
DIO24	41 7	DIO25	
GND	40 6	GND	
DIO26	39 5	DIO27	TERMINAL 1
GND	38 4	GND	TERMINAL 35
DIO28	37 3	DIO29	
GND	36 2	GND	(77)(77)
DIO30	35 1	DIO31	
	* <i>x</i> is the connector number. External Clock <i>x</i> is an input only.		CONNECTOR 1 (RDIO) CONNECTOR 2 (RDIO)

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#### <sup>1</sup>/<sub>-</sub> Tristate by default

<sup>2</sup> NI recommends minimizing long-term over/under-voltage exposure to the Digital I/O. Prolonged DC voltage stresses that violate the maximum and minimum digital input voltage ratings may reduce device longevity. Over/under-voltage stresses are considered prolonged if the cumulative time in the abnormal condition exceeds 1 year.